

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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Email & Skype: info@chipsmall.com Web: www.chipsmall.com

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LI1206H121R-10

UNCONTROLLED DOCUMENT

PHYSICAL DIMENSIONS:

(G)

IMPEDANCE

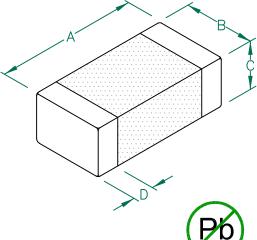
IMPEDANCE (Ω)

A 3.20 [.126] ± 0.20 [.008]

B 1.60 [.063] ± 0.20 [.008]

C 1.10 [.043] ± 0.20 [.008]

D 0.51 [.020] ± 0.25 [.010]

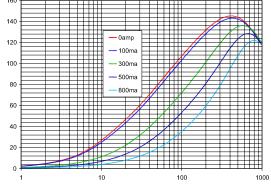


ELECTRICAL CHARACTERISTICS:										
Z @ 100M (Ω)	1Hz	DCR (Ω)	Rated Current							
Nominal	120									
Minimum	90									
Maximum	150	0.15	800 mA							

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 3000 PCS/REEL.
- 2. TERMINATION FINISH IS 100% TIN.
- 3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 4. OPERATING TEMP. RANGE: -40°C~+125°C. (INCLUDING SELF-HEATING)

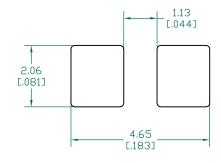
Z vs FREQUENCY IMPEDANCE UNDER DC BIAS



FREQUENCY (MHz)

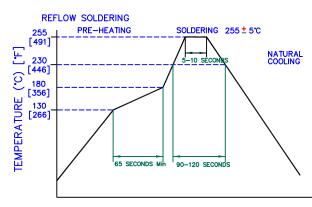
IZI . R. AND X vs. FREQUENCY

LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.762 (0.030) to this dimension)

RECOMMENDED SOLDERING CONDITIONS



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AGILENT E4991A RF Impedance/Material Analyzer HP 16194A Test Fixture. TEST REF. 3422

ROLS 2002/95/EC

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L					written consent of Laird Tech. Al		_			
L					reserved.					
	D	ADD OPERATING TEMPERATURE	08/05/13	QU	PROJECT/PART NUMBER:	T	REV	PART TY	PE:	DRAWN BY:
L		OPDATE LAIRD LOGO AND REFLOW CORVE			LI1206H121R-10		D co		FIRE	тмв
L	С		07/22/08		2/12/07/11/2/11		_			2
	В	CORRECT LANDPATTERN DIMS ADD ROHS	08/28/06	JRK		SCAL	E: N	TS	SHEET:	
Г	Α	ORIGINAL DRAFT	04/05/04	TMB	040.4	TOOL		-	2	of 2
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